

PATENT ABSTRACTS OF JAPAN

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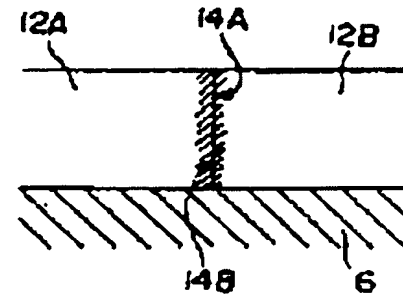
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(54) SPUTTERING TARGET AND MANUFACTURE THEREFOR**(57)Abstract:**

PURPOSE: To enhance the yield of a sputtering target formed by joining ends of plural platelike members.

CONSTITUTION: Ends 14A, 14B of a pair of adjacent platelike members 12A, 12B are butted at the joining parts and the members 12A, 12B are joined by melt-bonding the ends 14A, 14B. Since a gap is not formed between the joined parts of the platelike members, the resulting target can be used up to the bottom and the yield of the target can be enhanced.

**LEGAL STATUS**

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